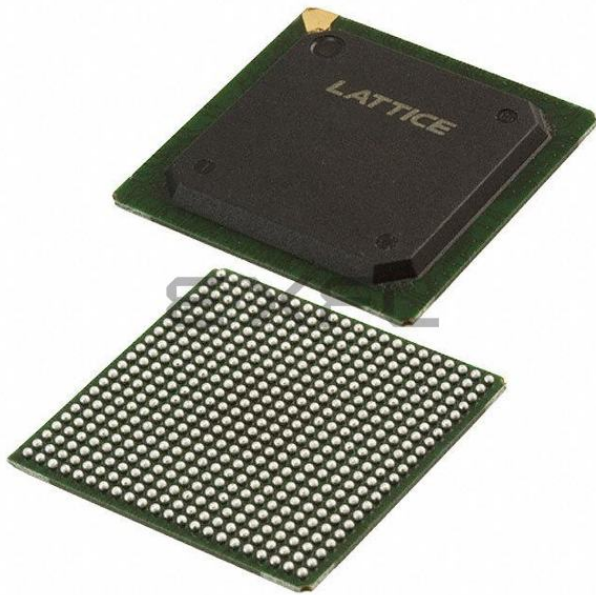




Welcome to [E-XFL.COM](https://www.e-xfl.com)

Understanding [Embedded - CPLDs \(Complex Programmable Logic Devices\)](#)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

Applications of Embedded - CPLDs

Details

Product Status	Obsolete
Programmable Type	In System Programmable
Delay Time tpd(1) Max	7.5 ns
Voltage Supply - Internal	3V ~ 3.6V
Number of Logic Elements/Blocks	24
Number of Macrocells	768
Number of Gates	-
Number of I/O	317
Operating Temperature	0°C ~ 90°C (TJ)
Mounting Type	Surface Mount
Package / Case	484-BBGA
Supplier Device Package	484-FPBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lc5768mv-75fn484c

Table 4. MFB Memory Configuration

Memory Mode	Max. Configuration Size ¹
Dual-port	8,192 x 1 4,096 x 2 2,048 x 4 1,024 x 8 512 x 16
Single-port, Pseudo Dual Port, FIFO	16,384 x 1 8,192 x 2 4,096 x 4 2,048 x 8 1,024 x 16 512 x 32
CAM	128 x 48

1. Smaller configurations are possible.

Input and Output

The data input and control signals to a MFB in memory mode are generated from inputs from the routing. Data signals are only available in the true non-inverted format. True or complemented versions of the inputs are available for generating the control signals. Data and flag outputs are fed from the MFB to the GRP and OSA. Unused inputs and outputs are not accessible in memory mode.

ROM Operation

In each of the memory modes it is possible to specify the power-on state of each bit in the memory array. This allows the memory to be used as ROM if desired.

Increased Depth And Width

Designs that require a memory depth or width that is greater than that support by a single MFB can be supported by cascading multiple blocks. For dual port, single port, and pseudo dual port modes additional width is easily provided by sharing address lines. Additional depth is supported by multiplexing the RAM output. For FIFO and CAM modes additional width is supported through the cascading of MFBs.

The Lattice design tools automatically combine blocks to support the memory size specified in the user's design.

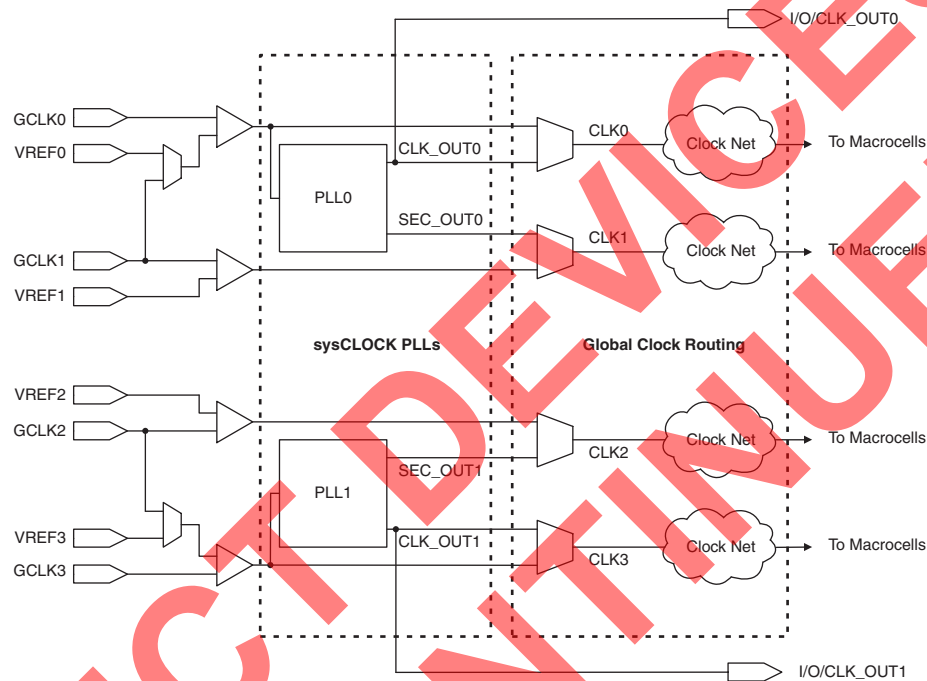
Bus Size Matching

All of the memory modes apart from CAM mode support different widths on each of the ports. The RAM bits are mapped LSB word 0 to MSB word 0, LSB word 1 to MSB word 1 and so on. Although the word size and number of words for each port varies this mapping scheme applies to each port.

Clock Distribution

The ispXPLD 5000MX family has four dedicated clock input pins: GCLK0-GCLK3. GCLK0 and GCLK3 can be routed through a PLL circuit or routed directly to the internal clock nets. The internal clock nets (CLK0-CLK3) are directly related to the dedicated clock pins (see Secondary Clock Divider exception when using the sysCLOCK circuit). These feed the registers in the MFBs. Note at each register there is the option of inverting the clock if required. Figure 14 shows the clock distribution network.

Figure 14. Clock Distribution Network



sysCLOCK PLL

The sysCLOCK PLL circuitry consists of Phase-Lock Loops (PLLs) and the various dividers, reset and feedback signals associated with the PLLs. This feature gives the user the ability to synthesize clock frequencies and generate multiple clock signals for routing within the device. Furthermore, it can generate clock signals that are de-skewed either at the board level or the device level.

The ispXPLD 5000MX devices provide two PLL circuits. PLL0 receives its clock inputs from GCLK 0 and provides outputs to CLK 0 (CLK 1 when using the secondary clock). PLL1 operates with signals from GCLK 3 and CLK 3 (CLK 2 when using the secondary clock). The optional outputs CLK_OUT can be routed to an I/O pin. The optional PLL_LOCK output is routed into the GRP. The optional input PLL_RST can be routed either from the GRP or directly from an I/O pin. The optional PLL_FBK into can be routed directly from a pin. Figure 15 shows the ispXPLD 5000MX PLL block diagram. Figure 16 shows the connection of optional inputs and outputs.

Absolute Maximum Ratings^{1, 2, 3}

	ispXPLD 5000MC 1.8V	ispXPLD 5000MB/V 2.5V/3.3V
Supply Voltage (V_{CC})	-0.5 to 2.5V	-0.5 to 5.5V
PLL Supply Voltage (V_{CCP})	-0.5 to 2.5V	-0.5 to 5.5V
Output Supply Voltage (V_{CCO})	-0.5 to 4.5V	-0.5 to 4.5V
IEEE 1149.1 TAP Supply Voltage (V_{CCJ})	-0.5 to 4.5V	-0.5 to 4.5V
Input Voltage Applied ^{4, 5}	-0.5 to 5.5V	-0.5 to 5.5V
Storage Temperature	-65 to 150°C	-65 to 150°C
Junction Temperature (T_J) with Power Applied	-55 to 150°C	-55 to 150°C

1. Stress above those listed under the "Absolute Maximum Ratings" may cause permanent damage to the device. Functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied (while programming, following the programming specifications).
2. Compliance with the Lattice [Thermal Management](#) document is required.
3. All voltages referenced to GND.
4. Overshoot and Undershoot of -2V to ($V_{IHMAX} + 2$) volts not to exceed 6V is permitted for a duration of <20ns.
5. A maximum of 64 I/Os per device with $V_{IN} > 3.6V$ is allowed.

Recommended Operating Conditions

Symbol	Parameter	Min.	Max.	Units
V_{CC}	Supply Voltage for 1.8V Devices (ispXPLD 5000MC)	1.65	1.95	V
	Supply Voltage for 2.5V Devices (ispXPLD 5000MB)	2.3	2.7	V
	Supply Voltage for 3.3V Devices (ispXPLD 5000MV)	3	3.6	V
V_{CCP}	PLL Block Supply Voltage for PLL 1.8V Devices	1.65	1.95	V
	PLL Block Supply Voltage for PLL 2.5V Devices	2.3	2.7	V
	PLL Block Supply Voltage for PLL 3.3V Devices	3	3.6	V
T_J	Junction Temperature (Commercial Operation)	0	90	C
	Junction Temperature (Industrial Operation)	-40	105	C

E²CMOS Erase Reprogram Specifications

Parameter	Min.	Max.	Units
Erase/Reprogram Cycle ¹	1,000	—	Cycles

1. Valid over commercial temperature range.

Hot Socketing Characteristics^{1, 2, 3, 4}

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
I_{DK}	Input or I/O Leakage Current	0 ≤ V_{IN} ≤ 3.0V	—	+/-50	+/-800	μA

1. Insensitive to sequence of V_{CC} and V_{CCO} when V_{CCO} ≤ 1.0V. For $V_{CCO} > 1.0V$, V_{CC} min must be present. However, assumes monotonic rise/fall rates for V_{CC} and V_{CCO} , provided ($V_{IN} - V_{CCO}$) ≤ 3.6V.
2. 0 ≤ V_{CC} ≤ V_{CC} (MAX), 0 ≤ V_{CCO} ≤ V_{CCO} (MAX)
3. I_{DK} is additive to I_{PU} , I_{PD} or I_{BH} . Device defaults to pull-up until non-volatile cells are active.
4. LVTTTL, LVCMOS only.

ispXPLD 5000MX Family Internal Switching Characteristics (Continued)

Over Recommended Operating Conditions

Parameter	Description	Base Parameter	-4		-45		-5		-52		-75		Units
			Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
t _{FIFOWES}	Write-Enable setup before Write Clock	—	2.33	—	2.33	—	2.91	—	2.91	—	3.03	—	ns
t _{FIFOWEH}	Write-Enable hold after Write Clock	—	-2.95	—	-2.95	—	-2.36	—	-2.36	—	-2.27	—	ns
t _{FIFORES}	Read-Enable setup before Read Clock	—	2.69	—	2.35	—	2.79	—	2.38	—	4.14	—	ns
t _{FIFOREH}	Read-Enable hold after Read Clock	—	-3.17	—	-3.17	—	-2.53	—	-2.53	—	-2.44	—	ns
t _{FIFORSTO}	Reset to Output Delay	—	—	3.30	—	3.30	—	4.13	—	4.13	—	4.29	ns
t _{FIFORSTR}	Reset Recovery Time	—	1.20	—	1.20	—	1.50	—	1.50	—	1.56	—	ns
t _{FIFORSTPW}	Reset Pulse Width	—	0.14	—	0.14	—	0.18	—	0.18	—	0.19	—	ns
t _{FIFORCLKO}	Read Clock to FIFO Out Delay	—	—	3.73	—	3.73	—	4.66	—	4.66	—	4.84	ns
CAM – Update Mode													
t _{CAMMSS}	Memory Select Setup before CLK	—	1.40	—	0.70	—	1.50	—	1.40	—	1.44	—	ns
t _{CAMMSH}	Memory Select Hold after CLK	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
t _{CAMENMSKS}	Enable Mask Register Setup Time before CLK	—	-0.27	—	-0.27	—	-0.22	—	-0.22	—	-0.21	—	ns
t _{CAMENMSKH}	Enable Mask Register Setup Time after CLK	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
t _{CAMADDS}	Address Setup Time before Clock	—	-0.27	—	-0.27	—	-0.22	—	-0.22	—	-0.21	—	ns
t _{CAMADDH}	Address Hold Time after Clock	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
t _{CAMDATAS}	Data Setup Time before Clock	—	-0.41	—	-0.41	—	-0.33	—	-0.33	—	-0.31	—	ns
t _{CAMDATAH}	Data Hold Time after Clock	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
t _{CAMDACS}	“Don’t Care” Setup Time before Clock	—	-0.27	—	-0.27	—	-0.22	—	-0.22	—	-0.21	—	ns
t _{CAMDCH}	“Don’t Care” Hold Time after Clock	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
t _{CAMRWS}	R/W Setup Time before Clock	—	-0.27	—	-0.27	—	-0.22	—	-0.22	—	-0.21	—	ns
t _{CAMRWH}	R/W Enable Hold Time after Clock	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
t _{CAMCES}	Clock Enable Setup Time before Clock	—	1.55	—	1.55	—	1.94	—	1.94	—	2.02	—	ns
t _{CAMCEH}	Clock Enable Hold Time after Clock	—	-2.95	—	-2.95	—	-2.36	—	-2.36	—	-2.27	—	ns

ispXPLD 5000MX Family Timing Adders (Continued)

Parameter	Description	Base Param.	-4		-45		-5		-52		-75		Units
			Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
HSTL_I_out	Using HSTL 2.5V, Class I	t_{IOBUF} , t_{IOEN} , t_{IODIS}	—	0.5	—	0.5	—	0.5	—	0.5	—	0.5	ns
HSTL_III_out	Using HSTL 2.5V, Class III	t_{IOBUF} , t_{IOEN} , t_{IODIS}	—	0.6	—	0.6	—	0.6	—	0.6	—	0.6	ns
HSTL_IV_out	Using HSTL 2.5V, Class IV	t_{IOBUF} , t_{IOEN} , t_{IODIS}	—	0.6	—	0.6	—	0.6	—	0.6	—	0.6	ns
LVDS_out	Using Low Voltage Differential Signaling (LVDS)	t_{IOBUF} , t_{IOEN} , t_{IODIS}	—	0.8	—	0.8	—	0.8	—	0.8	—	0.8	ns
LVPECL_out	Using Low Voltage PECL	t_{IOBUF} , t_{IOEN} , t_{IODIS}	—	0.3	—	0.3	—	0.3	—	0.3	—	0.3	ns
PCI_out	Using PCI Standard	t_{IOBUF} , t_{IOEN} , t_{IODIS}	—	0.6	—	0.6	—	0.6	—	0.6	—	0.6	ns
SSTL2_I_out	Using SSTL 2.5V, Class I	t_{IOBUF} , t_{IOEN} , t_{IODIS}	—	0.3	—	0.3	—	0.3	—	0.3	—	0.3	ns
SSTL2_II_out	Using SSTL 2.5V, Class II	t_{IOBUF} , t_{IOEN} , t_{IODIS}	—	0.5	—	0.5	—	0.5	—	0.5	—	0.5	ns
SSTL3_I_out	Using SSTL 3.3V, Class I	t_{IOBUF} , t_{IOEN} , t_{IODIS}	—	0.2	—	0.2	—	0.2	—	0.2	—	0.2	ns
SSTL3_II_out	Using SSTL 3.3V, Class II	t_{IOBUF} , t_{IOEN} , t_{IODIS}	—	0.4	—	0.4	—	0.4	—	0.4	—	0.4	ns

Timing v.1.8

Boundary Scan Timing Specifications

Over Recommended Operating Conditions

Parameter	Description	Min	Max	Units
t_{BTCP}	TCK [BSCAN] clock pulse width	40	—	ns
t_{BTCPH}	TCK [BSCAN] clock pulse width high	20	—	ns
t_{BTCPL}	TCK [BSCAN] clock pulse width low	20	—	ns
t_{BTS}	TCK [BSCAN] setup time	8	—	ns
t_{BTH}	TCK [BSCAN] hold time	10	—	ns
t_{BTRF}	TCK [BSCAN] rise/fall time	50	—	mV/ns
t_{BTCO}	TAP controller falling edge of clock to valid output	—	10	ns
$t_{BTCODIS}$	TAP controller falling edge of clock to valid disable	—	10	ns
t_{BTCOEN}	TAP controller falling edge of clock to valid enable	—	10	ns
t_{BTCRS}	BSCAN test capture register setup time	8	—	ns
t_{BTCRH}	BSCAN test capture register hold time	10	—	ns
t_{BUTCO}	BSCAN test update register, falling edge of clock to valid output	—	25	ns
$t_{BTUODIS}$	BSCAN test update register, falling edge of clock to valid disable	—	25	ns
$t_{BTUPOEN}$	BSCAN test update register, falling edge of clock to valid enable	—	25	ns

ispXPLD 5256MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Input	256 fpBGA Ball Number
			Macrocell 1	Macrocell 2		
1	4N	A16/CSB	A9	B9	A17	L5
1	5P	A18/READ	A10	B10	A19	N1
1	5N	A20/CCLK	A11	B11	A21	M2
-	-	VCC	-	-	-	VCC
-	-	DONE	-	-	-	M4
1	6P	A22	A12	B12	A23	N3
1	6N	A24	A13	B13	A25	P4
1	7P	A26	A14	B14	A27	N5
1	7N	A28	A15	B15	A29	M6
-	-	PROGRAMB	-	-	-	R3
-	-	GND (Bank 1)	-	-	-	GND (Bank 1)
-	-	VCCO1	-	-	-	VCCO1
-	-	CFG0	-	-	-	L8
1	8P	B2	A16	B16	B3	T7
1	8N	B4	A17	B17	-	R7
1	9P	B5	A18	B18	-	N7
1	9N	B6	A19	B19	B7	P7
1	10P	B8	A20	B20	B9	T8
1	10N	B10	A21	B21	B11	R8
1	11P	B12	A22	B22	B13	M8
1	11N	B14	A23	B23	B15	P8
1	-	B16/VREF1	-	-	B17	L9
1	12P	B18	A24	B24	B19	N8
1	12N	B20	A25	B25	-	M9
-	-	GND (Bank 1)	-	-	-	GND (Bank 1)
1	13P	B21	A26	B26	-	N10
-	-	VCCO1	-	-	-	VCCO1
1	13N	B22	A27	B27	B23	T9
1	14P	B24	A28	B28	B25	T10
1	14N	B26	A29	B29	B27	R9
-	-	VCC	-	-	-	VCC
1	15P	B28	A30	B30	B29	P9
1	15N	B30	A31	B31	B31	N9
2	16P	C0	C0	D0	C1	T11
2	16N	C2	C1	D1	C3	T12
2	17P	C4	C2	D2	-	P10
2	17N	C5	C3	D3	-	R10
2	18P	C6	C4	D4	C7	R11
-	-	VCCO2	-	-	-	VCCO2
2	18N	C8	C5	D5	C9	M10
-	-	GND (Bank 2)	-	-	-	GND (Bank 2)
2	19P	C10	C6	D6	C11	M11
2	19N	C12	C7	D7	C13	T13

ispXPLD 5256MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Input	256 fpBGA Ball Number
			Macrocell 1	Macrocell 2		
2	20P	C14	-	-	C15	P11
2	20N	C16/VREF2	-	-	C17	T14
2	21P	C18	C8	D8	C19	R12
2	21N	C20	C9	D9	-	R13
2	22P	C21	C10	D10	-	N11
2	22N	C22	C11	D11	C23	T15
2	23P	C24	C12	D12	C25	R14
2	23N	C26	C13	D13	C27	N12
2	24P	C28	C14	D14	C29	P12
2	24N	C30	C15	D15	C31	R15
-	-	VCCO2	-	-	-	VCCO2
-	-	GND (Bank 2)	-	-	-	GND (Bank 2)
2	25P	D0	-	-	D1	N15
2	25N	D2	-	-	D3	N14
2	26P	D4	C16	D16	-	N16
2	26N	D5	C17	D17	-	M16
2	27P	D6	C18	D18	D7	M14
2	27N	D8	C19	D19	D9	M15
-	-	VCC	-	-	-	VCC
2	28P	D10	C20	D20	D11	L13
2	28N	D12	C21	D21	D13	L12
2	29P	D14	C22	D22	D15	L15
2	29N	D16	C23	D23	D17	L16
-	-	GND	-	-	-	GND
2	30P	D18	C24	D24	D19	L14
-	-	VCCO2	-	-	-	VCCO2
2	30N	D20	C25	D25	-	K15
-	-	GND (Bank 2)	-	-	-	GND (Bank 2)
2	31P	D21	C26	D26	-	K14
2	31N	D22	C27	D27	D23	K12
2	32P	D24	C28	D28	D25	K13
2	32N	D26	C29	D29	D27	J13
2	33P	D28	C30	D30	D29	J14
2	33N	D30	C31	D31	D31	J12
-	-	TOE	-	-	-	J15
-	-	RESET	-	-	-	J11
-	-	GOE0	-	-	-	H11
-	-	GOE1	-	-	-	H13
-	-	GNDP	-	-	-	See Power Supply and NC Connections Table
-	GCLK3N	GCLK2	-	-	-	H15
-	-	VCCP	-	-	-	See Power Supply and NC Connections Table
-	GCLK3P	GCLK3	-	-	-	H16

ispXPLD 5256MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Input	256 fpBGA Ball Number
			Macrocell 1	Macrocell 2		
3	34N	E30	-	-	E31	H14
3	34P	E28	-	-	E29	G16
3	35N	E26	-	-	E27	G15
3	35P	E24/PLL_FBK1	-	-	E25	F15
3	36N	E22/PLL_RST1	E27	F27	E23	H12
3	36P	E21	E26	F26	-	G14
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)
3	37N	E20	E25	F25	-	F16
-	-	VCCO3	-	-	-	VCCO3
3	37P	E18	E24	F24	E19	E16
-	-	GND	-	-	-	GND
3	38N	E16	E23	F23	E17	G13
3	38P	E14	E22	F22	E15	G12
3	39N	E12	E21	F21	E13	F14
3	39P	E10/CLK_OUT1	E20	F20	E11	E15
-	-	VCC	-	-	-	VCC
3	40N	E8	E19	F19	E9	D12
3	40P	E6	E18	F18	E7	B14
3	41N	E5	E17	F17	-	C13
3	41P	E4	E16	F16	-	A14
3	42N	E2	E31	F31	E3	A13
3	42P	E0	E30	F30	E1	B13
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)
-	-	VCCO3	-	-	-	VCCO3
3	43N	F30	E15	F15	F31	B11
3	43P	F28	E14	F14	F29	C11
3	44N	F26	E13	F13	F27	B10
3	44P	F24	E12	F12	F25	A10
3	45N	F22	E11	F11	F23	C10
3	45P	F21	E10	F10	-	D10
3	46N	F20	E9	F9	-	C9
3	46P	F18	E8	F8	F19	E9
3	47N	F16/VREF3	E29	F29	F17	D9
3	47P	F14	E28	F28	F15	F9
3	48N	F12	E7	F7	F13	A9
3	48P	F10	E6	F6	F11	F8
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)
3	49N	F8	E5	F5	F9	E8
-	-	VCCO3	-	-	-	VCCO3
3	49P	F6	E4	F4	F7	A8
3	50N	F5	E3	F3	-	B9
3	50P	F4	E2	F2	-	D8
-	-	VCC	-	-	-	VCC

ispXPLD 5256MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Input	256 fpBGA Ball Number
			Macrocell 1	Macrocell 2		
3	51N	F2	E1	F1	F3	B8
3	51P	F0	E0	F0	F1	C8
0	52N	G30	G31	H31	G31	B7
0	52P	G28	G30	H30	G29	A7
-	-	GND	-	-	-	NC
0	53N	G26	G29	H29	G27	D7
0	53P	G24	G28	H28	G25	C7
0	54N	G22	G27	H27	G23	B6
-	-	VCCO0	-	-	-	VCCO0
0	54P	G21	G26	H26	-	E7
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)
0	55N	G20	G25	H25	-	E6
0	55P	G18	G24	H24	G19	A6
0	56N	G16/VREF0	G3	H3	G17	A5
0	56P	G14	G2	H2	G15	A4
0	57N	G12	G23	H23	G13	B5
0	57P	G10	G22	H22	G11	A3
0	58N	G8	G21	H21	G9	B4
0	58P	G6	G20	H20	G7	B3
0	59N	G5	G19	H19	-	C5
0	59P	G4	G18	H18	-	C6
0	60N	G2	G1	H1	G3	D5
0	60P	G0	G0	H0	G1	D6
-	-	VCCO0	-	-	-	VCCO0
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)

Global Clock LVDS pair options: GCLK0 and GCLK1, as well as GCLK2 and GCLK3, can be paired together to receive differential clocks; where GCLK0 and GCLK3 are the positive LVDS inputs

ispXPLD 5512MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Input	208 PQFP Pin Number	256 fpBGA Ball Number	484 fpBGA Ball Number
			Macrocell 1	Macrocell 2				
1	13P	B24	A16	—	B25	—	T4	V6
—	—	V _{CCO1}	—	—	—	57	V _{CCO1}	V _{CCO1}
1	13N	B26	A18	—	B27	—	T5	V7
1	14P	B28	A20	—	B29	—	R4	Y5
1	14N	B30	A22	—	B31	—	N6	AA5
1	15P	C0	—	—	C1	—	R5	Y6
1	15N	C2	—	—	C3	—	P6	Y7
1	16P	C4	—	—	C5	—	—	AA6
1	16N	C8	—	—	C9	—	—	AA7
1	17P	C10	—	—	C11	—	—	W7
1	17N	C12	—	—	C13	—	M7 ¹	V8
1	18P	C16	—	—	C17	—	T6	W8
1	18N	C18	—	—	C19	—	R6	U9
—	—	GND0 (Bank 1)	—	—	—	—	GND (Bank 1)	GND (Bank 1)
—	—	CFG0	—	—	—	58	L8	U10
—	—	V _{CCO1}	—	—	—	—	V _{CCO1}	V _{CCO1}
1	19P	C24	B16	D16	C25	59	T7	AB7
1	19N	C26	B17	D17	C27	60	R7	AA8
1	20P	C28	B18	D18	C29	61	N7	AB8
1	20N	D0	B19	D19	D1	62	P7	AB9
1	21P	D2	B20	D20	D3	63	T8	W9
1	21N	D4	B21	D21	D5	64	R8	Y9
1	22P	D6	B22	D22	D7	65	M8	AB10
1	22N	D8	B23	D23	D9	66	P8	AA10
1	—	D10/V _{REF1}	—	—	D11	67	L9	W10
1	23P	D12	B24	D24	D13	68	N8	Y10
1	23N	D16	B25	D25	D17	69	M9	Y11
—	—	GND (Bank 1)	—	—	—	70	GND (Bank 1)	GND (Bank 1)
1	24P	D18	B26	D26	D19	71	N10	V9
—	—	V _{CCO1}	—	—	—	72	V _{CCO1}	V _{CCO1}
1	24N	D20	B27	D27	D21	73	T9	V10
1	25P	D22	B28	D28	D23	74	T10	AA11
1	25N	D24	B29	D29	D25	75	R9	AB11
—	—	VCC	—	—	—	76	VCC	VCC
1	26P	D26	B30	D30	D27	77	P9	U11
1	26N	D28	B31	D31	D29	78	N9	V11
2	27P	E0	F0	H0	E1	79	T11	AB12
2	27N	E2	F1	H1	E3	80	T12	AA12
—	—	GND	—	—	—	81	NC	GND
—	—	GND	—	—	—	—	GND	GND
2	28P	E4	F2	H2	E5	82	P10	Y12
2	28N	E6	F3	H3	E7	83	R10	AA13
2	29P	E8	F4	H4	E9	84	R11	V12

ispXPLD 5512MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Input	208 PQFP Pin Number	256 fpBGA Ball Number	484 fpBGA Ball Number
			Macrocell 1	Macrocell 2				
0	96N	M12	M23	O23	M13	196	B5	A10
0	96P	M10	M22	O22	M11	197	A3	A9
0	97N	M8	M21	O21	M9	198	B4	C9
0	97P	M6	M20	O20	M7	199	B3	D9
0	98N	M5	M19	O19	—	200	C5	F9
0	98P	M4	M18	O18	—	201	C6	E9
0	99N	M2	M1	O1	M3	202	D5	A8
—	—	V _{CC00}	—	—	—	—	V _{CC00}	V _{CC00}
0	99P	M0	M0	O0	M1	203	D6	B8
—	—	GND (Bank 0)	—	—	—	—	GND (Bank 0)	GND (Bank 0)
0	100N	N30	O29	—	N31	—	—	A7
0	100P	N28	O28	—	N29	—	—	B7
0	101N	N26	O27	—	N27	—	—	A5
0	101P	N24	O26	—	N25	—	—	B5
0	102N	N22	O25	—	N23	—	—	B6
0	102P	N21	O24	—	—	—	—	C7
0	103N	N20	O23	—	—	—	—	E8
0	103P	N18	O22	—	N19	—	—	E7
0	104N	N16	O21	—	N17	—	—	E6
0	104P	N14	O20	—	N15	—	—	D6
0	105N	N12	O19	—	N13	—	—	D8
—	—	V _{CC00}	—	—	—	204	V _{CC00}	V _{CC00}
0	105P	N10	O18	—	N11	—	—	F8
—	—	GND (Bank 0)	—	—	—	205	GND (Bank 0)	GND (Bank 0)
0	106N	N8	O17	—	N9	—	—	F7
0	106P	N6	O16	—	N7	—	—	D7
0	107N	N5	O15	—	—	206	A2	C6
0	107P	N4	O14	—	—	207	B2	C5
0	108N	N2	O13	—	N3	—	—	C4
0	108P	N0	O12	—	N1	—	—	D5

1. Not available for differential pair.

Global Clock LVDS pair options: GCLK0 and GCLK1, as well as GCLK2 and GCLK3, can be paired together to receive differential clocks; where GCLK0 and GCLK3 are the positive LVDS inputs.

ispXPLD 51024MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/Function	Alternate Outputs		Alternate Input	484 fpBGA Ball Number	672 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
-	-	VCCO2	-	-	-	VCCO2	VCCO2
2	79N	N10	P5	N5	N11	—	V26
-	-	GND (Bank 2)	-	-	-	GND (Bank 2)	GND (Bank 2)
2	80P	N12	P6	N6	N13	—	V22
2	80N	N14	P7	N7	N15	—	V23
2	81P	N16	P8	N8	N17	—	V24
2	81N	N18	P9	N9	N19	—	V25
2	82P	N20	P10	N10	N21	—	U20
2	82N	N22	P11	N11	N23	—	T20
2	83P	N24	P12	N12	N25	—	U26
2	83N	N26	P13	N13	N27	—	U25
2	84P	N28	P14	N14	N29	—	U21
-	-	VCCO2	-	-	-	VCCO2	VCCO2
2	84N	N30	P15	N15	N31	—	T21
-	-	GND (Bank 2)	-	-	-	GND (Bank 2)	GND (Bank 2)
2	85P	P0	P16	N16	P1	—	U22
2	85N	P2	P17	N17	P3	—	U23
2	86P	P4	P18	N18	P5	—	U24
2	86N	P6	P19	N19	P7	—	T24
2	87P	P8	P20	N20	P9	—	T23
2	87N	P10	P21	N21	P11	—	T22
2	88P	P12	P22	N22	P13	—	T25
-	-	VCC	-	-	-	VCC	VCC
2	88N	P14	P23	N23	P15	—	R26
-	-	GND	-	-	-	GND	GND
2	89P	P16	P24	N24	P17	—	R25
-	-	VCCO2	-	-	-	VCCO2	VCCO2
2	89N	P18	P25	N25	P19	—	R24
-	-	GND (Bank 2)	-	-	-	GND (Bank 2)	GND (Bank 2)
2	90P	P20	P26	N26	P21	—	R21
2	90N	P22	P27	N27	P23	—	P21
2	91P	P24	P28	N28	P25	—	R22
2	91N	P26	P29	N29	P27	—	R23
2	92P	P28	P30	N30	P29	—	R20
2	92N	P30	P31	N31	P31	—	P20
-	-	TOE	-	-	-	W22	P25
-	-	RESET	-	-	-	V22	P24
-	-	GOE0	-	-	-	T22	P23
-	-	GOE1	-	-	-	R22	P22
-	-	GNDP	-	-	-	See Power Supply and NC Connections Table	
-	GCLK3N	GCLK2	-	-	-	P16	N26
-	-	VCCP	-	-	-	See Power Supply and NC Connections Table	

ispXPLD 51024MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/Function	Alternate Outputs		Alternate Input	484 fpBGA Ball Number	672 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
-	GCLK3P	GCLK3	-	-	-	N16	N24
3	93N	R0	T31	R31	R1	J22	N23
3	93P	R2	T30	R30	R3	H22	N22
3	94N	R4	T29	R29	R5	N19	M26
3	94P	R6	T28	R28	R7	P15	M25
3	95N	R8	T27	R27	R9	P21	M23
3	95P	R10	T26	R26	R11	N15	M22
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)	GND (Bank 3)
3	96N	R12	T25	R25	R13	M15	N20
-	-	VCCO3	-	-	-	VCCO3	VCCO3
3	96P	R14	T24	R24	R15	N20	M20
-	-	GND	-	-	-	GND	GND
3	97N	R16	T23	R23	R17	P22	N21
3	97P	R18	T22	R22	R19	N21	M21
3	98N	R20	T21	R21	R21	N17	M24
3	98P	R22	T20	R20	R23	M20	L24
3	99N	R24	T19	R19	R25	P17	L23
-	-	VCC	-	-	-	VCC	VCC
3	99P	R26	T18	R18	R27	P18	L22
3	100N	R28	T17	R17	R29	M21	L25
3	100P	R30	T16	R16	R31	M17	K26
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)	GND (Bank 3)
3	101N	T0	T15	R15	T1	L20	K25
-	-	VCCO3	-	-	-	VCCO3	VCCO3
3	101P	T2	T14	R14	T3	N18	K24
3	102N	T4	T13	R13	T5	L21	K23
3	102P	T6	T12	R12	T7	M18	K22
3	103N	T8	T11	R11	T9	L22	J25
3	103P	T10	T10	R10	T11	L17	J24
3	104N	T12	T9	R9	T13	K22	L21
3	104P	T14	T8	R8	T15	L18	K21
3	105N	T16	T7	R7	T17	K21	L20
3	105P	T18	T6	R6	T19	K18	K20
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)	GND (Bank 3)
3	106N	T20	T5	R5	T21	K20	J23
-	-	VCCO3	-	-	-	VCCO3	VCCO3
3	106P	T22	T4	R4	T23	K17	J22
3	107N	T24	T3	R3	T25	K19	J26
3	107P	T26	T2	R2	T27	J17	H26
3	108N	T28	T1	R1	T29	E22	H25
3	108P	T30/PLL_FBK1	T0	R0	T31	E21	H24
3	109N	U0/PLL_RST1	X27	V27	U1	G22	H23
3	109P	U2	X26	V26	U3	F21	H22

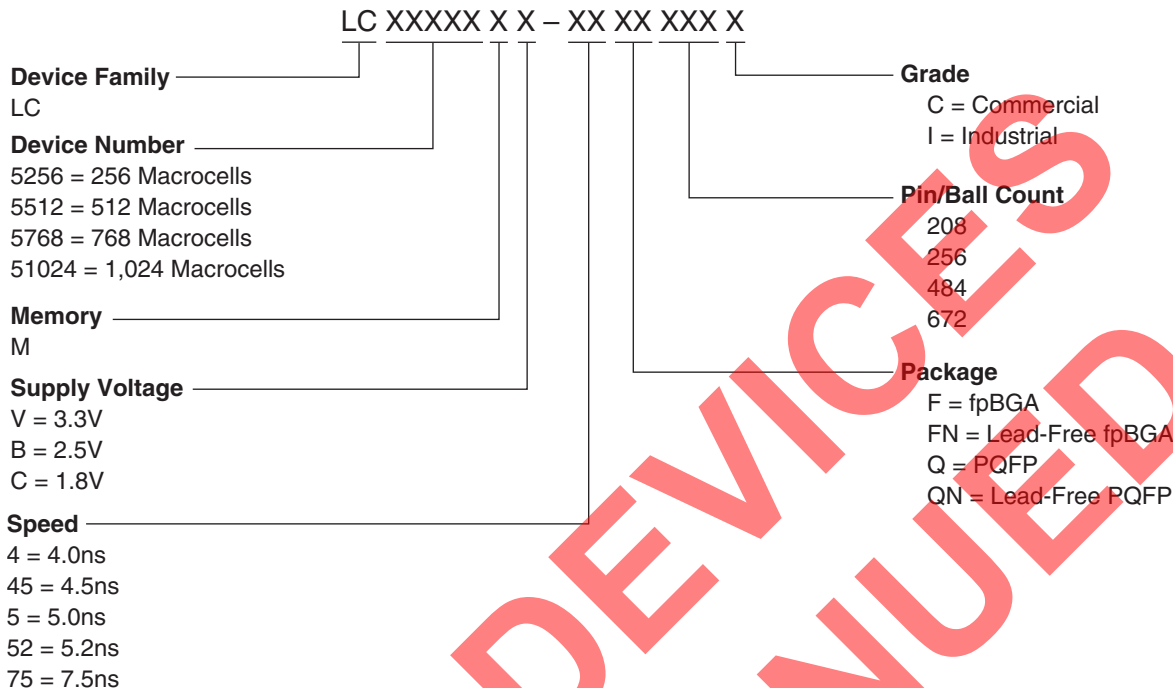
ispXPLD 51024MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/Function	Alternate Outputs		Alternate Input	484 fpBGA Ball Number	672 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)	GND (Bank 3)
3	110N	U4	X25	V25	U5	H21	J21
-	-	VCCO3	-	-	-	VCCO3	VCCO3
3	110P	U6	X24	V24	U7	G21	H21
-	-	GND	-	-	-	GND	GND
3	111N	U8	X23	V23	U9	D22	G25
3	111P	U10	X22	V22	U11	D21	G24
3	112N	U12	X21	V21	U13	J20	G23
3	112P	U14/CLK_OUT1	X20	V20	U15	J19	G22
3	113N	U16	V31	-	U17	E20	J20
-	-	VCC	-	-	-	VCC	VCC
3	113P	U18	V30	U30	U19	F20	H20
3	114N	U20	V29	U28	U21	H17	G26
3	114P	U22	V28	U26	U23	H18	F25
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)	GND (Bank 3)
3	115N	U24	V27	-	U25	J18	F24
-	-	VCCO3	-	-	-	VCCO3	VCCO3
3	115P	U26	V26	-	U27	H19	F23
3	116N	U28	V25	-	U29	G20	G21
3	116P	U30	V24	-	U31	G19	F22
-	-	GND	-	-	-	GND	GND
3	117N	V0	V23	-	V1	C22	F26
-	-	VCC	-	-	-	VCC	VCC
3	117P	V2	V22	-	V3	C21	E26
3	118N	V4	V21	-	V5	D20	E25
3	118P	V6	V20	-	V7	C19	E24
3	119N	V8	V19	-	V9	F19	E23
3	119P	V10	V18	-	V11	E19	E22
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)	GND (Bank 3)
3	120N	V12	V17	-	V13	G18	D26
-	-	VCCO3	-	-	-	VCCO3	VCCO3
3	120P	V14	V16	-	V15	F18	D25
3	121N	V16	V15	-	V17	B20	D24
3	121P	V18	V14	-	V19	B19	D23
3	122N	V20	V13	-	V21	A20	C26
3	122P	V22	V12	-	V23	A19	C25
3	123N	V24	X19	V19	V25	D18	G19
3	123P	V26	X18	V18	V27	C18	F19
3	124N	V28	X17	V17	V29	G17	G18
3	124P	V30	X16	V16	V31	F16	F18
3	125N	W0	X31	V31	W1	E17	F20
3	125P	W2	X30	V30	W3	D17	E20
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)	GND (Bank 3)

ispXPLD 51024MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/Function	Alternate Outputs		Alternate Input	484 fpBGA Ball Number	672 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
0	142N	Y26	Y29	AA29	Y27	B11	A10
0	142P	Y24	Y28	AA28	Y25	A11	A9
0	143N	Y22	Y27	AA27	Y23	F11	A8
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	143P	Y20	Y26	AA26	Y21	F10	A7
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	144N	Y18	Y25	AA25	Y19	E10	A6
0	144P	Y16	Y24	AA24	Y17	C10	A5
0	145N	Y14/VREF0	Y3	AA3	Y15	D10	A4
0	145P	Y12	Y2	AA2	Y13	B10	A3
0	146N	Y10	Y23	AA23	Y11	A10	B10
0	146P	Y8	Y22	AA22	Y9	A9	B9
0	147N	Y6	Y21	AA21	Y7	C9	B8
0	147P	Y4	Y20	AA20	Y5	D9	B7
0	148N	Y2	Y19	AA19	Y3	F9	B6
0	148P	Y0	Y18	AA18	Y1	E9	B5
0	149N	Z30	Y1	AA1	Z31	A8	B4
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	149P	Z28	Y0	AA0	Z29	B8	B3
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	150N	Z26	AA29	-	Z27	A7	C10
0	150P	Z24	AA28	-	Z25	B7	C9
0	151N	Z22	AA27	-	Z23	A5	C8
0	151P	Z20	AA26	-	Z21	B5	C7
0	152N	Z18	AA25	-	Z19	B6	C6
0	152P	Z16	AA24	-	Z17	C7	C5
0	153N	Z14	AA23	-	Z15	E8	C4
0	153P	Z12	AA22	-	Z13	E7	D5
0	154N	Z10	AA21	-	Z11	E6	D9
-	-	VCC	-	-	-	VCC	VCC
0	154P	Z8	AA20	-	Z9	D6	D8
-	-	GND	-	-	-	GND	GND
0	155N	Z6	AA19	-	Z7	D8	D7
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	155P	Z4	AA18	-	Z5	F8	D6
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	156N	Z2	AA17	-	Z3	F7	F9
0	156P	Z0	AA16	-	Z1	D7	E9
0	157N	AA30	AA15	-	AA31	C6	F7
0	157P	AA28	AA14	-	AA29	C5	F8
0	158N	AA26	AA13	-	AA27	C4	G8
0	158P	AA24	AA12	-	AA25	D5	G9

Part Number Description



Ordering Information

Note: For voltage families offered in industrial temperature grades and for all but the slowest commercial speed grade, the speed grades on these devices are dual marked. For example, the commercial speed grade -45XXXXC is also marked with the industrial grade -75I. The commercial grade is always one speed grade faster than the associated dual mark industrial grade. The slowest commercial speed grade is marked as commercial grade only. In addition, the fastest commercial speed grade (-5) for the LC5768MB/MV devices, at Lattice's discretion, will utilize either a commercial grade only single-mark or a dual-mark format in conjunction with the slower industrial speed grade (-75).

Conventional Packaging

ispXPLD 5000MC (1.8V) Commercial Devices

Device	Part Number	Macrocells	Voltage (V)	t _{PD} (ns)	Package	Pin/Ball Count	I/O	Grade
LC5256MC	LC5256MC-4F256C	256	1.8	4.0	fpBGA	256	141	C
	LC5256MC-5F256C	256	1.8	5.0	fpBGA	256	141	C
	LC5256MC-75F256C	256	1.8	7.5	fpBGA	256	141	C
LC5512MC	LC5512MC-45Q208C	512	1.8	4.5	PQFP	208	149	C
	LC5512MC-75Q208C	512	1.8	7.5	PQFP	208	149	C
	LC5512MC-45F256C	512	1.8	4.5	fpBGA	256	193	C
	LC5512MC-75F256C	512	1.8	7.5	fpBGA	256	193	C
	LC5512MC-45F484C	512	1.8	4.5	fpBGA	484	253	C
	LC5512MC-75F484C	512	1.8	7.5	fpBGA	484	253	C

ispXPLD 5000MB (2.5V) Industrial Devices

Device	Part Number	Macrocells	Voltage (V)	t _{PD} (ns)	Package	Pin/Ball Count	I/O	Grade
LC5256MB	LC5256MB-5F256I	256	2.5	5.0	fpBGA	256	141	I
	LC5256MB-75F256I	256	2.5	7.5	fpBGA	256	141	I
LC5512MB	LC5512MB-75Q208I	512	2.5	7.5	PQFP	208	149	I
	LC5512MB-75F256I	512	2.5	7.5	fpBGA	256	193	I
	LC5512MB-75F484I	512	2.5	7.5	fpBGA	484	253	I
LC5768MB	LC5768MB-75F256I	768	2.5	7.5	fpBGA	256	193	I
	LC5768MB-75F484I	768	2.5	7.5	fpBGA	484	317	I
LC51024MB	LC51024MB-75F484I	1024	2.5	7.5	fpBGA	484	317	I
	LC51024MB-75F672I	1024	2.5	7.5	fpBGA	672	381	I

ispXPLD 5000MV (3.3V) Commercial Devices

Device	Part Number	Macrocells	Voltage (V)	t _{PD} (ns)	Package	Pin/Ball Count	I/O	Grade
LC5256MV	LC5256MV-4F256C	256	3.3	4.0	fpBGA	256	141	C
	LC5256MV-5F256C	256	3.3	5.0	fpBGA	256	141	C
	LC5256MV-75F256C	256	3.3	7.5	fpBGA	256	141	C
LC5512MV	LC5512MV-45Q208C	512	3.3	4.5	PQFP	208	149	C
	LC5512MV-75Q208C	512	3.3	7.5	PQFP	208	149	C
	LC5512MV-45F256C	512	3.3	4.5	fpBGA	256	193	C
	LC5512MV-75F256C	512	3.3	7.5	fpBGA	256	193	C
	LC5512MV-45F484C	512	3.3	4.5	fpBGA	484	253	C
	LC5512MV-75F484C	512	3.3	7.5	fpBGA	484	253	C
	LC5512MV-75F484C	512	3.3	7.5	fpBGA	484	253	C
LC5768MV	LC5768MV-5F256C	768	3.3	5.0	fpBGA	256	193	C
	LC5768MV-75F256C	768	3.3	7.5	fpBGA	256	193	C
	LC5768MV-5F484C	768	3.3	5.0	fpBGA	484	317	C
	LC5768MV-75F484C	768	3.3	7.5	fpBGA	484	317	C
LC51024MV	LC51024MV-52F484C	1024	3.3	5.2	fpBGA	484	317	C
	LC51024MV-75F484C	1024	3.3	7.5	fpBGA	484	317	C
	LC51024MV-52F672C	1024	3.3	5.2	fpBGA	672	381	C
	LC51024MV-75F672C	1024	3.3	7.5	fpBGA	672	381	C

ispXPLD 5000MV (3.3V) Industrial Devices

Device	Part Number	Macrocells	Voltage (V)	t _{PD} (ns)	Package	Pin/Ball Count	I/O	Grade
LC5256MV	LC5256MV-5F256I	256	3.3	5.0	fpBGA	256	141	I
	LC5256MV-75F256I	256	3.3	7.5	fpBGA	256	141	I
LC5512MV	LC5512MV-75Q208I	512	3.3	7.5	PQFP	208	149	I
	LC5512MV-75F256I	512	3.3	7.5	fpBGA	256	193	I
	LC5512MV-75F484I	512	3.3	7.5	fpBGA	484	253	I
LC5768MV	LC5768MV-75F256I	768	3.3	7.5	fpBGA	256	193	I
	LC5768MV-75F484I	768	3.3	7.5	fpBGA	484	317	I
LC51024MV	LC51024MV-75F484I	1024	3.3	7.5	fpBGA	484	317	I
	LC51024MV-75F672I	1024	3.3	7.5	fpBGA	672	381	I

Lead-Free Packaging

ispXPLD 5000MC (1.8V) Lead-Free Commercial Devices

Device	Part Number	Macrocells	Voltage (V)	t _{PD} (ns)	Package	Pin/Ball Count	I/O	Grade
LC5256MC	LC5256MC-4FN256C	256	1.8	4.0	Lead-free fpBGA	256	141	C
	LC5256MC-5FN256C	256	1.8	5.0	Lead-free fpBGA	256	141	C
	LC5256MC-75FN256C	256	1.8	7.5	Lead-free fpBGA	256	141	C
LC5512MC	LC5512MC-45QN208C	512	1.8	4.5	Lead-free PQFP	208	149	C
	LC5512MC-75QN208C	512	1.8	7.5	Lead-free PQFP	208	149	C
	LC5512MC-45FN256C	512	1.8	4.5	Lead-free fpBGA	256	193	C
	LC5512MC-75FN256C	512	1.8	7.5	Lead-free fpBGA	256	193	C
	LC5512MC-45FN484C	512	1.8	4.5	Lead-free fpBGA	484	253	C
	LC5512MC-75FN484C	512	1.8	7.5	Lead-free fpBGA	484	253	C
LC5768MC	LC5768MC-5FN256C	768	1.8	5.0	Lead-free fpBGA	256	193	C
	LC5768MC-75FN256C	768	1.8	7.5	Lead-free fpBGA	256	193	C
	LC5768MC-5FN484C	768	1.8	5.0	Lead-free fpBGA	484	317	C
	LC5768MC-75FN484C	768	1.8	7.5	Lead-free fpBGA	484	317	C
LC51024MC	LC51024MC-52FN484C	1024	1.8	5.2	Lead-free fpBGA	484	317	C
	LC51024MC-75FN484C	1024	1.8	7.5	Lead-free fpBGA	484	317	C
	LC51024MC-52FN672C	1024	1.8	5.2	Lead-free fpBGA	672	381	C
	LC51024MC-75FN672C	1024	1.8	7.5	Lead-free fpBGA	672	381	C

ispXPLD 5000MC (1.8V) Lead-Free Industrial Devices

Device	Part Number	Macrocells	Voltage (V)	t _{PD} (ns)	Package	Pin/Ball Count	I/O	Grade
LC5256MC	LC5256MC-5FN256I	256	1.8	5.0	Lead-free fpBGA	256	141	I
	LC5256MC-75FN256I	256	1.8	7.5	Lead-free fpBGA	256	141	I
LC5512MC	LC5512MC-75QN208I	512	1.8	7.5	Lead-free PQFP	208	149	I
	LC5512MC-75FN256I	512	1.8	7.5	Lead-free fpBGA	256	193	I
	LC5512MC-75FN484I	512	1.8	7.5	Lead-free fpBGA	484	253	I
LC5768MC	LC5768MC-75FN256I	768	1.8	7.5	Lead-free fpBGA	256	193	I
	LC5768MC-75FN484I	768	1.8	7.5	Lead-free fpBGA	484	317	I
LC51024MC	LC51024MC-75FN484I	1024	1.8	7.5	Lead-free fpBGA	484	317	I
	LC51024MC-75FN672I	1024	1.8	7.5	Lead-free fpBGA	672	381	I

ispXPLD 5000MV (3.3V) Lead-Free Commercial Devices (Continued)

Device	Part Number	Macrocells	Voltage (V)	t _{PD} (ns)	Package	Pin/Ball Count	I/O	Grade
LC5512MV	LC5512MV-45QN208C	512	3.3	4.5	Lead-free PQFP	208	149	C
	LC5512MV-75QN208C	512	3.3	7.5	Lead-free PQFP	208	149	C
	LC5512MV-45FN256C	512	3.3	4.5	Lead-free fpBGA	256	193	C
	LC5512MV-75FN256C	512	3.3	7.5	Lead-free fpBGA	256	193	C
	LC5512MV-45FN484C	512	3.3	4.5	Lead-free fpBGA	484	253	C
	LC5512MV-75FN484C	512	3.3	7.5	Lead-free fpBGA	484	253	C
LC5768MV	LC5768MV-5FN256C	768	3.3	5.0	Lead-free fpBGA	256	193	C
	LC5768MV-75FN256C	768	3.3	7.5	Lead-free fpBGA	256	193	C
	LC5768MV-5FN484C	768	3.3	5.0	Lead-free fpBGA	484	317	C
	LC5768MV-75FN484C	768	3.3	7.5	Lead-free fpBGA	484	317	C
LC51024MV	LC51024MV-52FN484C	1024	3.3	5.2	Lead-free fpBGA	484	317	C
	LC51024MV-75FN484C	1024	3.3	7.5	Lead-free fpBGA	484	317	C
	LC51024MV-52FN672C	1024	3.3	5.2	Lead-free fpBGA	672	381	C
	LC51024MV-75FN672C	1024	3.3	7.5	Lead-free fpBGA	672	381	C

ispXPLD 5000MV (3.3V) Lead-Free Industrial Devices

Device	Part Number	Macrocells	Voltage (V)	t _{PD} (ns)	Package	Pin/Ball Count	I/O	Grade
LC5256MV	LC5256MV-5FN256I	256	3.3	5.0	Lead-free fpBGA	256	141	I
	LC5256MV-75FN256I	256	3.3	7.5	Lead-free fpBGA	256	141	I
LC5512MV	LC5512MV-75QN208I	512	3.3	7.5	Lead-free PQFP	208	149	I
	LC5512MV-75FN256I	512	3.3	7.5	Lead-free fpBGA	256	193	I
	LC5512MV-75FN484I	512	3.3	7.5	Lead-free fpBGA	484	253	I
LC5768MV	LC5768MV-75FN256I	768	3.3	7.5	Lead-free fpBGA	256	193	I
	LC5768MV-75FN484I	768	3.3	7.5	Lead-free fpBGA	484	317	I
LC51024MV	LC51024MV-75FN484I	1024	3.3	7.5	Lead-free fpBGA	484	317	I
	LC51024MV-75FN672I	1024	3.3	7.5	Lead-free fpBGA	672	381	I

For Further Information

In addition to this data sheet, the following technical notes may be helpful when designing with the ispXPLD 5000MX family:

- TN1000 – [sysIO Usage Guidelines for Lattice Devices](#)
- TN1003 – [sysCLOCK PLL Usage Guide for ispXPGA, ispGDX2, ispXPLD and ispMACH 5000VG Devices](#)
- TN1031 – [Power Estimation in ispXPLD 5000MX Devices](#)
- TN1030 – [Using Memory in ispXPLD 5000MX Devices](#)
- TN1026 – [ispXP Configuration Usage Guidelines](#)